

Data Sheet

Description

The KGF65A6H and MGF65A6H are 650 V Field Stop IGBTs. Sanken original trench structure decreases gate capacitance, and achieves high speed switching and switching loss reduction. Thus, these Field Stop IGBTs can improve the efficiency of your circuit.

Features

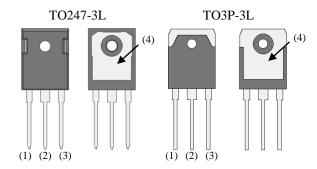
- Low Saturation Voltage
- High Speed Switching
- With Integrated Fast Recovery Diode
- RoHS Compliant

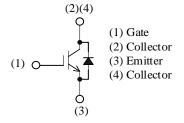
• V _{CE}	650 V
• I _C (T _C = 100 °C)	60 A
• Short Circuit Withstand Time	10 μs
• V _{CE(sat)}	1.9 V typ.
• $t_f (T_J = 175 ^{\circ}C)$	
• V _F	1.8 V typ.

Applications

- Welding Invertor
- PFC Circuit

Packages





Not to scale

Selection Guide

Part Number	Package
KGF65A6H	TO247-3L
MGF65A6H	TO3P-3L

KGF65A6H, MGF65A6H

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit	Remarks
Collector to Emitter Voltage	V_{CE}		650	V	
Gate to Emitter Voltage	V_{GE}		±30	V	
Continuous Collector Current (1)	T	$T_C = 25 ^{\circ}C$	80 ⁽²⁾	A	
Continuous Conector Current	I_{C}	$T_C = 100 ^{\circ}C$	60	A	
Pulsed Collector Current	I _{C(PULSE)}	$PW \le 1 \text{ ms},$ duty cycle $\le 1\%$	180	A	
Diode Continuous Forward Current (1)	T	$T_C = 25 ^{\circ}C$	40 ⁽²⁾	A	
Diode Continuous Forward Current	I_{F}	$T_C = 100 ^{\circ}C$	30	A	
Diode Pulsed Forward Current	$I_{F(PULSE)}$	$PW \le 1 \text{ ms},$ duty cycle $\le 1\%$	100	A	
Short Circuit Withstand Time	t_{SC}	$V_{GE} = 15 \text{ V},$ $V_{CE} = 400 \text{ V},$ $T_{J} = 175 ^{\circ}\text{C}$	10	μs	
Power Dissipation	P_D	T _C = 25 °C	405	W	
Operating Junction Temperature	T_{J}		175	°C	
Storage Temperature	T_{STG}		-55 to 150	°C	

Thermal Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Remarks
Thermal Resistance of IGBT (Junction to Case)	$R_{\theta JC}(IGBT)$		_	_	0.38	°C/W	
Thermal Resistance of Diode (Junction to Case)	$R_{\theta JC}(Di)$		_	_	1.15	°C/W	

 $[\]overline{\ \ \ }^{(1)}$ I_C and I_F are determined by the maximum junction temperature for TO3P-3L package. (2) Determined by bonding wires capability.

KGF65A6H, MGF65A6H

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector to Emitter Breakdown Voltage	V _{(BR)CES}	$I_C = 100 \mu A, V_{GE} = 0 V$	650			V	
Collector to Emitter Leakage Current	I_{CES}	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$	_		100	μΑ	
Gate to Emitter Leakage Current	I_{GES}	$V_{GE} = \pm 30 \text{ V}$	_		±500	nA	
Gate Threshold Voltage	$V_{\text{GE(TH)}}$	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}$	4.0	5.5	7.0	V	
Collector to Emitter Saturation Voltage	V _{CE(sat)}	$V_{GE} = 15 \text{ V}, I_{C} = 60 \text{ A}$		1.9	2.37	V	
Input Capacitance	C_{ies}	$V_{CE} = 20 \text{ V},$		3500			
Output Capacitance	C_{oes}	$V_{GE} = 0 V$,	_	330		pF	
Reverse Transfer Capacitance	C _{res}	f = 1.0 MHz		170			
Gate Charge	Q_{g}	$V_{CE} = 520 \text{ V}, I_{C} = 60 \text{ A}, $ $V_{GE} = 15 \text{ V}$	_	110		nC	
Turn-On Delay Time	$t_{d(on)}$		_	50			
Rise Time	t _r			70		ns	
Turn-Off Delay Time	$t_{d(off)}$	$T_{\rm J} = 25 ^{\circ}{\rm C};$		130			
Fall Time	t_{f}	see Figure 1		40			
Turn-on Energy (3)	Eon	_		1.4		т	
Turn-off Energy	$E_{ m off}$			1.3		mJ	
Turn-On Delay Time	t _{d(on)}			50			
Rise Time	t _r			70			
Turn-Off Delay Time	$t_{d(off)}$	$T_{\rm J} = 175 {\rm ^{\circ}C};$		160		ns	
Fall Time	t_{f}	see Figure 1	_	60			
Turn-on Energy (3)	Eon	1		2.1		Т	
Turn-off Energy	$E_{\rm off}$			1.8		mJ	
Emitter to Collector Diode Forward Voltage	V_{F}	$I_F = 30 \text{ A}$	_	1.8	_	V	
Emitter to Collector Diode Reverse Recovery Time	t_{rr}	$I_F = 30 \text{ A},$ $di/dt = 700 \text{ A/}\mu\text{s}$		50		ns	

⁽³⁾ Energy losses include the reverse recovery of diode.

Test Circuits and Waveforms

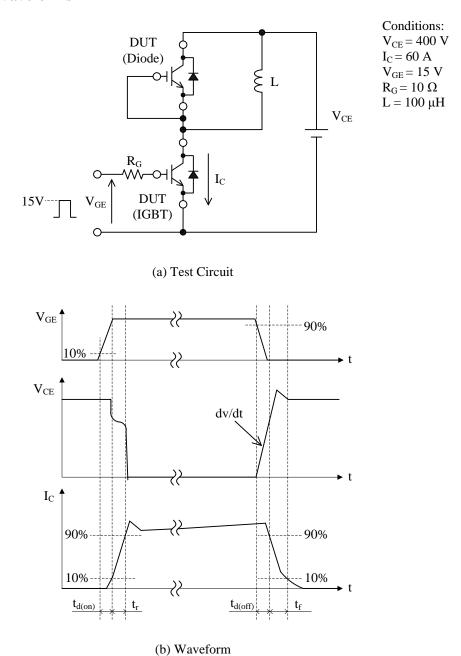


Figure 1. Test Circuits and Waveforms of dv/dt and Switching Time

Rating and Characteristic Curves

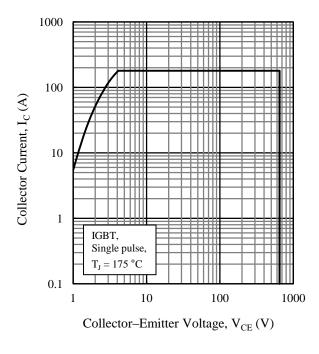


Figure 2. IGBT Reverse Bias Safe Operating
Area

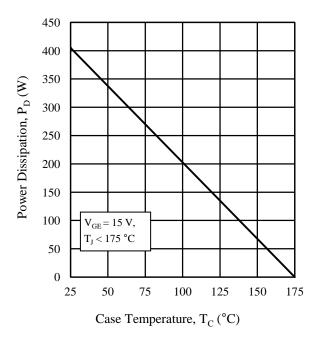


Figure 4. Power Dissipation vs. Case Temperature

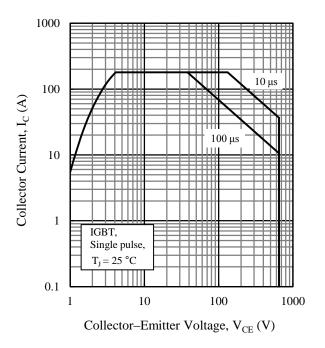


Figure 3. IGBT Safe Operating Area

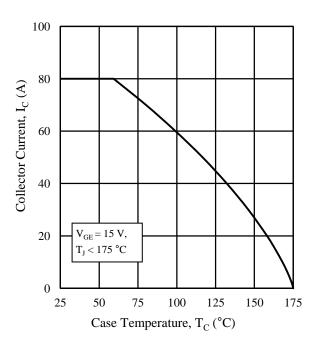


Figure 5. Collector Current vs. Case Temperature

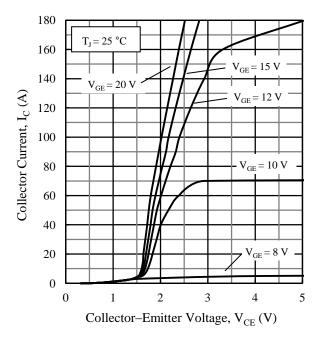


Figure 6. Output Characteristics ($T_J = 25$ °C)

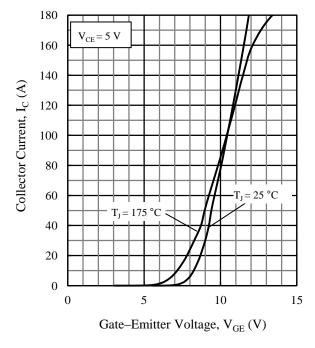


Figure 8. Transfer Characteristics

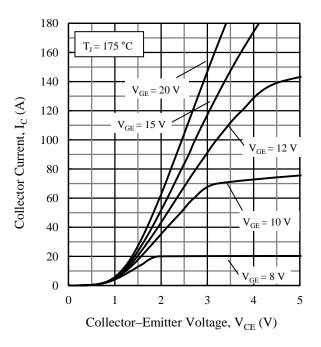


Figure 7. Output Characteristics ($T_J = 175$ °C)

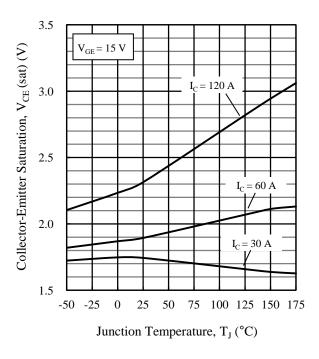


Figure 9. Saturation Voltage vs. Junction Temperature

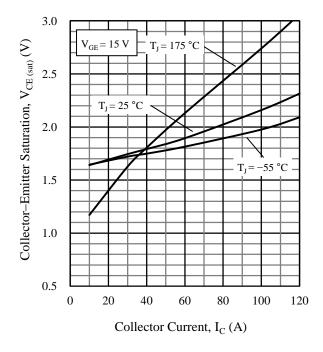


Figure 10. Saturation Voltage vs. Collector Current

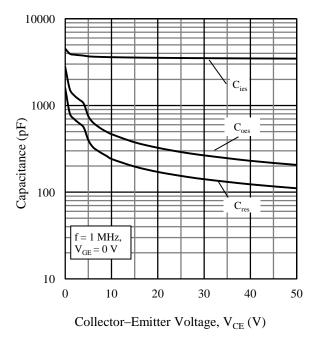
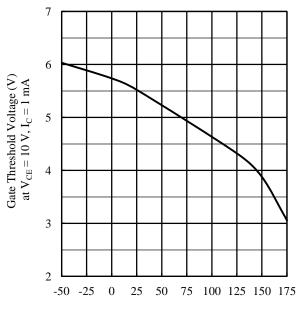


Figure 12. Capacitance Characteristics



Junction Temperature, T_J (°C)

Figure 11. Gate Threshold Voltage vs. Junction Temperature

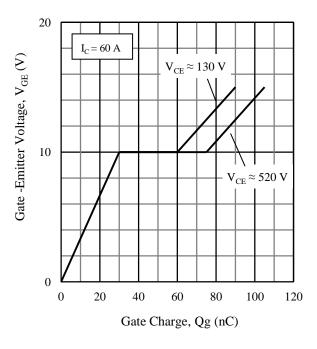


Figure 13. Typical Gate Charge

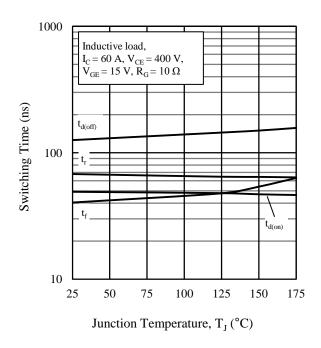


Figure 14. Switching Time vs. Junction Temperature

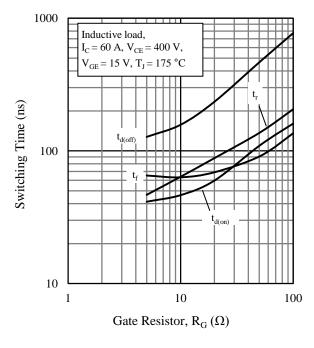


Figure 16. Switching Time vs. Gate Resistor

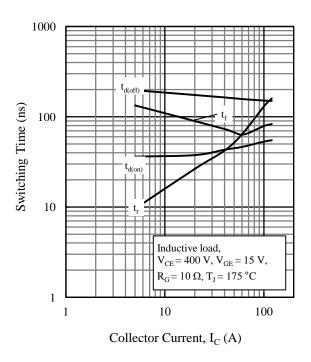


Figure 15. Switching Time vs. Collector Current

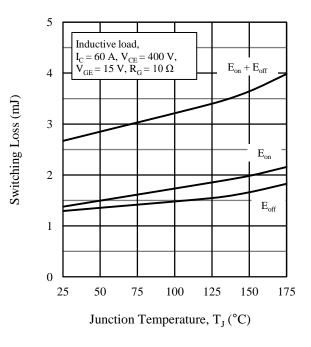


Figure 17. Switching Loss vs. Junction Temperature

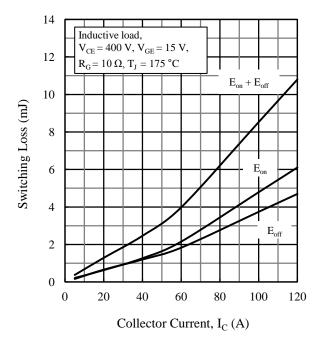


Figure 18. Switching Loss vs. Collector Current

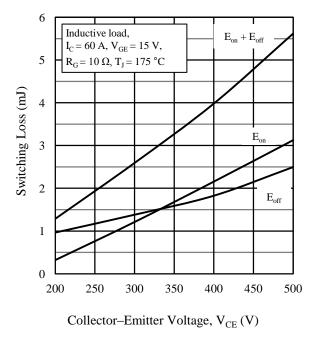


Figure 20. Switching Loss vs. Collector–Emitter Voltage

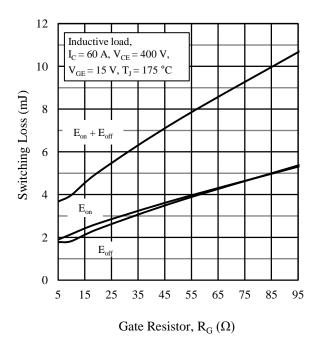


Figure 19. Switching Loss vs. Gate Resistor

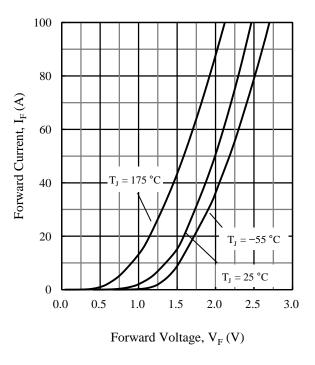


Figure 21. Diode Forward Characteristics

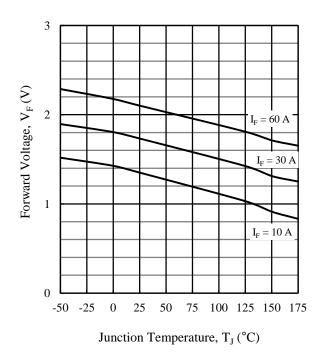


Figure 22. Diode Forward Voltage vs. Junction Temperature

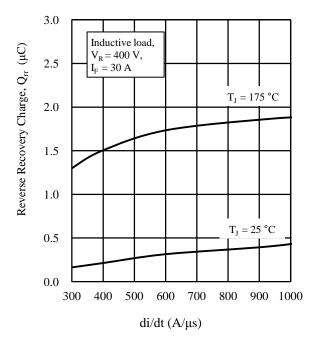


Figure 24. Diode Reverse Recovery Charge vs. $\frac{di}{dt}$

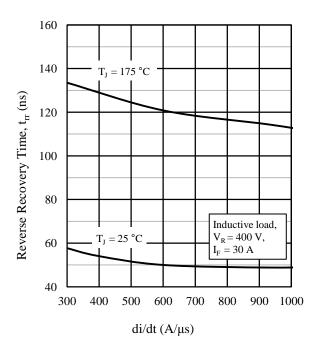


Figure 23. Diode Reverse Recovery Time vs. di/dt

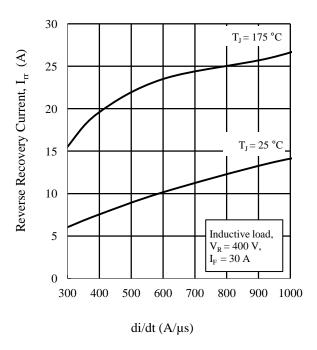


Figure 25. Diode Reverse Recovery Current vs. $\frac{di}{dt}$

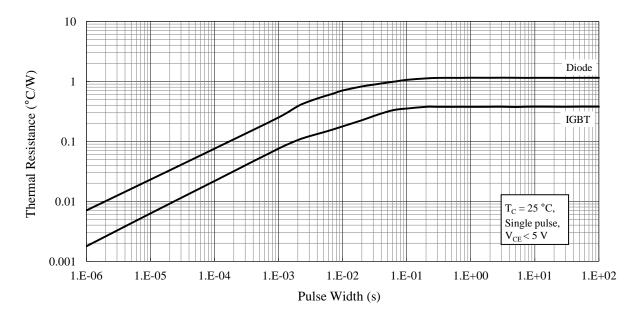
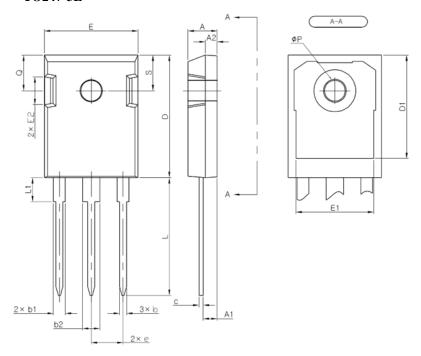


Figure 26. Transient Thermal Resistance

Physical Dimensions

• TO247-3L

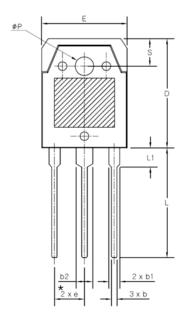


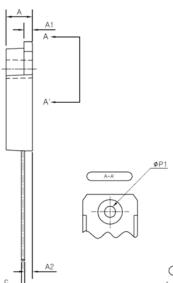
SYMBOL	MIN	NOM	MAX
Α	4.83	5.02	5.21
A1	2.29	2.41	2.54
A2	1.91	2.04	2.16
b	1.14	1.27	1.40
b1	1.91	2.10	2.20
b2	2.92	3.10	3.20
С	0.61	0.71	0.80
D	20.80	21.07	21.34
D1	17.43	17.63	17.83
Е	15.75	15.94	16.13
E1	13.06	13.26	13.46
E2	4.32	4.58	4.83
е	5.25	5.45	5.65
L	19.81	20.19	20.57
L1	3.81	4.07	4.32
ΦP	3.55	3.60	3.65
Q	5.59	5.90	6.20
S		6.15 BSC	
S	6.15 BSC		

NOTE

1. THESE DIMENSION DO NOT INCLUDE MOLD PROTRUSION

• TO3P-3L





SYMBOL	MIN	NOM	MAX
Α	4.60	4.80	5.00
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
С	0.55	0.60	0.75
D	19.70	19.90	20.10
Е	15.40	15.60	15.80
* _e	5.25	5.45	5.65
L	19.80	20.00	20.20
L1	3.30	3.50	3.70
ΦP	3.30	3.40	3.50
ØP1	3.10	3.20	3.30
S	4.80	5.00	5.20

NOTE

1. THESE DIMENSIONS DO NOT INCLUDE PROTRUSIONS OF THE MOLD. 2. THE "()" MARK IS THE REFERENCE

NOTES:

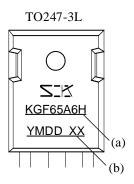
- All dimensions in millimeters
- Pin treatment for TO247 and TO3P: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time within the following limits:

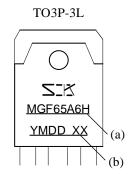
 260 ± 5 °C 10 ± 1 s, 2 times (flow)

 380 ± 10 °C 3.5 ± 0.5 s, 1 time (soldering iron)

- Soldering should be at a distance of at least 1.5 mm from the body of the products.
- The recommended screw torque for TO247, TO3P and TO3PF: 0.686 N·m to 0.882 N·m (7 kgf·cm to 9 kgf·cm)

Marking Diagram





- (a) Part Number
- (b) Lot Number

Y is the last digit of the year of manufacture (0 to 9)

M is the month of the year (1 to 9, O, N, or D)

DD is the day of the month (01 to 31)

XX is the control number

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 STGFW40V60F
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 APT25GR120S

 APT30GN60BDQ2G
 APT30GN60BG
 APT30GS60BRDQ2G
 APT30N60BC6
 APT35GP120JDQ2
 APT36GA60B

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 APT68GA60B
 APT70GR65B
 APT70GR65B2SCD30
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